
PRODUCT SPECIFICATION

Model No	T147HG-C16-13-TP
Product Name	1.47 TFT LCD Module
Version	V1.0
Date	2024-03-09

- ☐ Preliminary Specification
- ☒ Final Specification

PREPARED BY	CHECKED BY	APPROVED BY

Revision History

Version	Date	Page	Revise record	Remarks
V1.0	2024-03-08	-	First issued	-

TABLE OF CONTENT

NO.Contents	Page
1. General Parameter	4
2. Physical drawing	4
3. Mechanical Dimension	5
4. Absolute Maximum Ratings	6
5. DC Characteristics	6
6. Backlight Characteristic	6
7. Pins Definitions.	7
8. Schematic Diagram	7
9. Timing Characteristics	8
10. Optical Characteristics	9
11. Reliability	12
12. Precautions	13

1. General Parameter

NO.	Features	Details	Unit
1	Display Size(Diagonal)	1.47"	Inch
2	LCD type	IPS TFT	-
3	Display Mode	Transmissive/Normally black	-
4	Resolution	172RGB(H) x 320(V)	Pixels
5	Viewing Direction	ALL	-
6	Module size	23.90(W) x 39.90(H) x 2.81(T)	mm
7	Active Area	17.65(W) x 32.83(H)	mm
8	Pixel Size	0.1026(W) x 0.1026(H)	mm
9	Color arrangement	RGB Vertical stripe	-
10	Interface	4 Line SPI	-
11	Display Colors	262K	-
12	Driver IC	ST7789	-
13	TP Driver IC	CST816D	-
14	With or Without Touch Panel	Tape touch	-
15	Operating Temperature	-20℃~70℃	℃
16	Storage Temperature	-30℃~80℃	℃
17	Weight	5.0	g

Note 1: Please refer to the mechanical drawing.

2. Physical drawing



3. Mechanical Dimension

8

7

6

5

4

3

2

1

正视图

侧视图

背视图

Technical drawing of the T147HG-C16-13-TP LCM showing front, side, and back views with dimensions.

Notes:

1. Display Size (显示尺寸): 1.47" TFT

2. Viewing Direction (视角方向): ALL

3. Display Mode (显示模式): Transmissive / Normally Black

4. Resolution (分辨率): 172*RGB*320

5. Color (颜色): 262K

6. Drive IC (驱动IC): GC9307

6. TP Drive IC (触摸IC): CST816D

7. Interface (接口): 4-Wire SPI

8. Backlight (背光): White IF=60mA, VF=3.0V(TYP)

9. Luminance (透屏亮度): 350cd/m²(TYP)

10. Operating temperature (工作温度): -20°C+70°C

11. Storage temperature (存储温度): -30°C+80°C

12. RoHS (欧盟标准): YES

*Unspecified Tolerance (未定义公差): ±0.1

Property

Requirement

IC	CST816D
Glass Thickness	1.1mm
Surface Hardness	6H(750g)
Light Transmission	≥85%
Operating Temperature	-20~70°C
Storage Temperature	-30~80°C
Operating Humidity	45~85 RH
Storage Humidity	45~85 RH

Backlight Circuit Diagram:

(背光电路图)

Backlight circuit diagram showing LEDA, LEDK, and ICD components.

Property

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IC	CST816D
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Storage Humidity	45~85 RH

LCM NO:

T147HG-C16-13-TP

VERSION

V1

SCALE: FIT

DESIGNED BY:

CHECKED BY:

APPROVED BY:

SHEET: 1 OF 1

YYQ

ZY

UNIT: MM

DATE

2024-03-09

2024-03-09

REV

V1

REVISION RECORD

First edition

SIGN

YYQ

DATA

20240309

NO.

PIN NAME

1	LED-K
2	LED-A
3	D/CX
4	SDA
5	CSX
6	RESX
7	SCL
8	GND
9	VCI
10	TP-SCL
11	TP-SDA
12	TP-INT
13	TP-RESET
14	GND
15~16	NC

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深圳市金逸晨电子有限公司

4. Absolute Maximum Ratings

Item	Symbol	Min.	Max.	Unit
Supply Voltage	V _{CI}	-0.3	4.6	V
Operating temperature	T _{op}	-20	70	°C
Storage temperature	T _{st}	-30	80	°C

Note 1: If Ambient temperature below 50°C, the maximal humidity is 90%RH, if Ambient temperature over 50°C, absolute humidity should be less than 60%RH.

Note 2: The response time will be extremely slow when the operating temperature is around -10°C, and the back ground will become darker at high temperature operating.

Note 3: If one of the above items is exceeded its maximum limitation momentarily, the quality of the product may be degraded. Absolute maximum limitation, therefore, specify the values exceeding which the product may be physically damaged. Be sure to use the product within the recommend range.

5. DC Characteristics

Item	Symbol	Min.	Typ.	Max.	Unit
Supply Voltage	V _{CI}	2.5	2.8	3.3	V
Input high voltage	V _{IN}	0.7*V _{CI}	-	V _{CI}	V
Input low voltage	V _{IL}	GND	-	0.3*V _{CI}	V
Output high voltage	V _{OH}	0.8*V _{CI}	-	V _{CI}	V
Output low voltage	V _{OL}	GND	-	0.2*V _{CI}	V
Input Current	I _{IN}	-	20	-	mA

6. Backlight Characteristic

Item	Symbol	Min.	Typ.	Max.	Unit	Condition
Forward Voltage	V _F	-	3.0	-	V	-
Forward Current	I _F	-	60	-	mA	-
Power dissipation	P _d	-	180	-	mW	-
LED Life Time(25 °C)	-	-	10000	-	Hrs	-

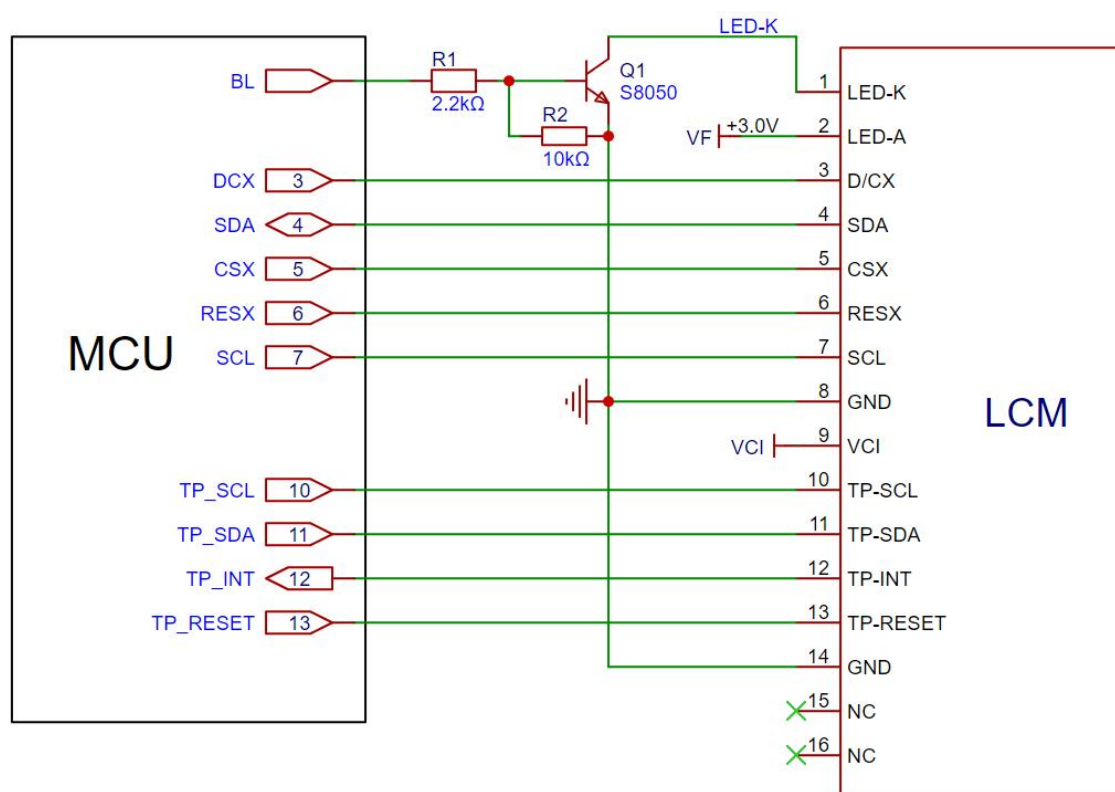
Note: LED life time defined as follows: The final brightness is at 50% of original brightness. Typical operating life time is estimated data.

7. Pins Definitions.

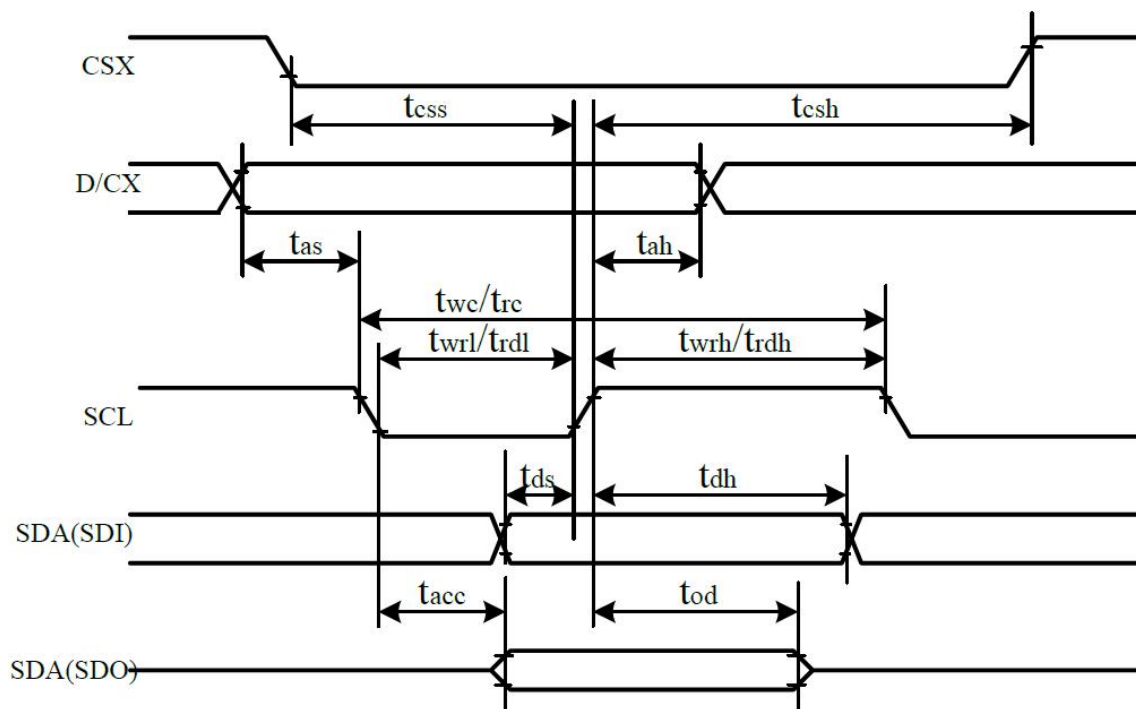
Pin.No	Symbol	Description
1	LED-K	Backlight cathode.
2	LED-A	Backlight anode.
3	D/CX	Display data/command selection (RS) pin. D/CX='1': display data or parameter. D/CX='0': register index / command.
4	SDA	- SPI interface input pin. - The data is latched on the rising edge of the SCL signal.
5	CSX	Chip selection pin. Low-active.
6	RESX	This signal will reset the device and must be applied to properly initialize the chip.
7	SCL	Serial interface clock.
8	GND	Ground.
9	VCI	Supply Voltage(2.5-3.3V)
10	TP-SCL	TP Serial clock pin.
11	TP-SDA	TP Serial data input / output.
12	TP-INT	Touch interrupt input pin
13	TP-RESET	TP Reset pin
14	GND	Ground.
15	NC	No connect.
16	NC	No connect.

NOTE: The backlight LED can be powered separately or share a set of voltage supply with the VCI.

8. Schematic Diagram.



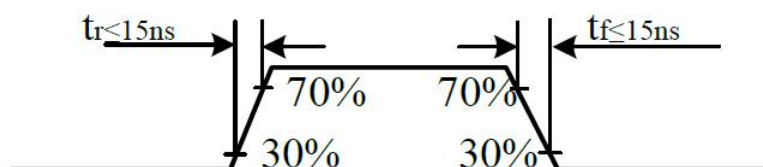
9. Timing Characteristics.



4-SPI Serial Data Transfer Interface Characteristics

Note: $T_a = 25\text{ }^{\circ}\text{C}$, $IOVCC=1.65\text{V to }3.3\text{V}$, $VCI=2.5\text{V to }3.3\text{V}$, $AGND=VSS=0\text{V}$

Signal	Symbol	Parameter	min	max	Unit	Description
CSX	t_{css}	Chip select time (Write)	20	-	ns	
	t_{csh}	Chip select hold time (Read)	40	-	ns	
SCL	t_{wc}	Serial Clock Cycle (Write)	10	-	ns	
	t_{wrh}	SCL "H" Pulse Width (Write)	5	-	ns	
	t_{wrl}	SCL "L" Pulse Width (Write)	5	-	ns	
	t_{rc}	Serial Clock Cycle (Read)	150	-	ns	
	t_{rdh}	SCL "H" Pulse Width (Read)	60	-	ns	
	t_{rdl}	SCL "L" Pulse Width (Read)	60	-	ns	
D/CX	t_{as}	D/CX setup time	10	-	ns	
	t_{ah}	D/CX hold time (Write/Read)	10	-	ns	
SDA/SDI (Input)	t_{ds}	Data setup time (Write)	5	-	ns	
	t_{dh}	Data hold time (Write)	5	-	ns	
SDA/SDO (Output)	t_{acc}	Access time (Read)	10	-	ns	



10. Optical Characteristics.

Item		Symbol	Condition	Min.	Typ.	Max.	Unit	Note
Transmittance (with Polarizer)		T (%)	Θ=0 Normal viewing angle	3.2	3.6	—	%	Measuring with normal polarizer, Reference Only Base on Vop=4.3V
Transmittance (without Polarizer)		T (%)		11.6	12.9	—	%	
Contrast Ratio		CR		1000	1300	—	—	(1)(2)
Response Time		TR+TF		—	35	40	msec	(1)(3)
Color Gamut	(%)			65	70	—	%	C-light
Color Chromaticity (CIE1931)	White	W _x		-0.02	0.300	+0.02	—	(1)(4) CF glass C-light
		W _y			0.341			
	Red	R _x			0.659		—	
		R _Y			0.326			
	Green	G _x	0.277		—			
		G _Y	0.589					
	Blue	B _x	0.136		—			
		B _Y	0.128					
Viewing Angle	Hor.	Θ _L	CR>10	80	85	—	—	(1)(4) Measuring with normal polarizer, Reference Only
		Θ _R		80	85	—		
	Ver.	Θ _U		80	85	—		
		Θ _D		80	85	—		
Optima View Direction		Free						(5)

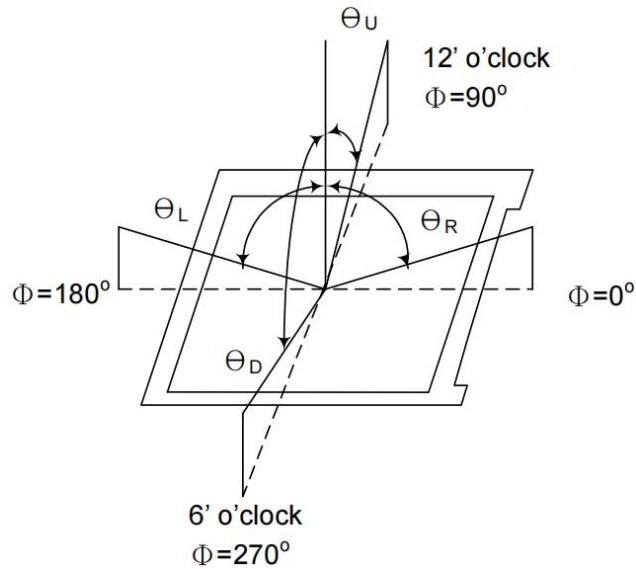
Measuring Condition

- Measuring surrounding: dark room
- Ambient temperature: 25±2°C
- 15min. warm-up time.

Measuring Equipment

- FPM520 of Westar Display technologies, INC., which utilized SR-3 for Chromaticity and BM-5A for other optical characteristics.

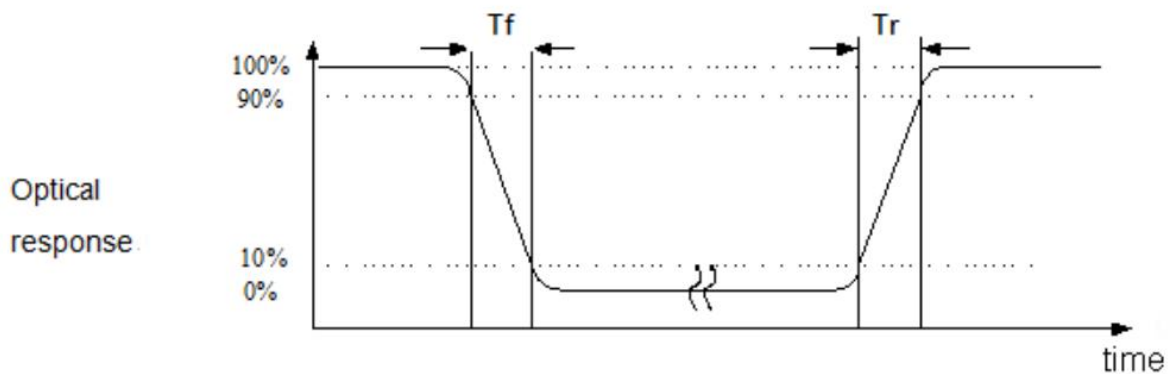
Note (1) Definition of Viewing Angle:



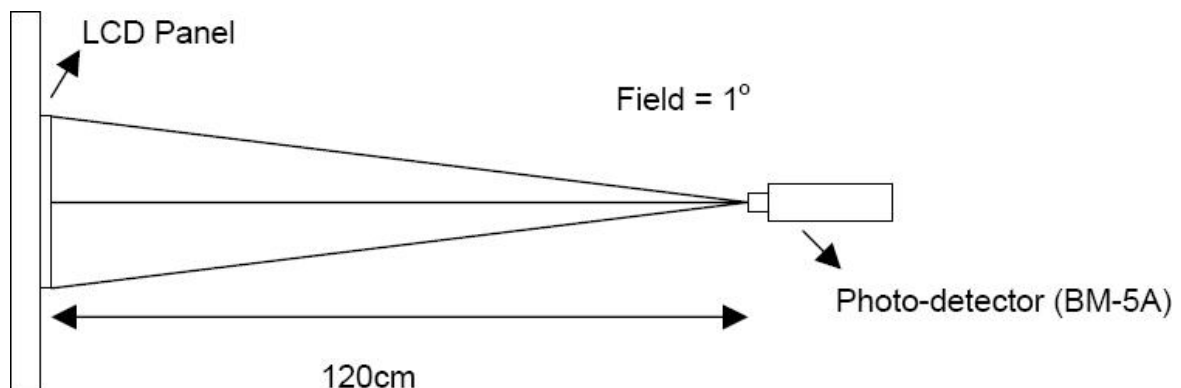
Note (2) Contrast ratio is calculated by the following formula:

$$\text{Contrast ratio (CR)} = \frac{\text{Brightness on the "white" state}}{\text{Brightness on the "black" state}}$$

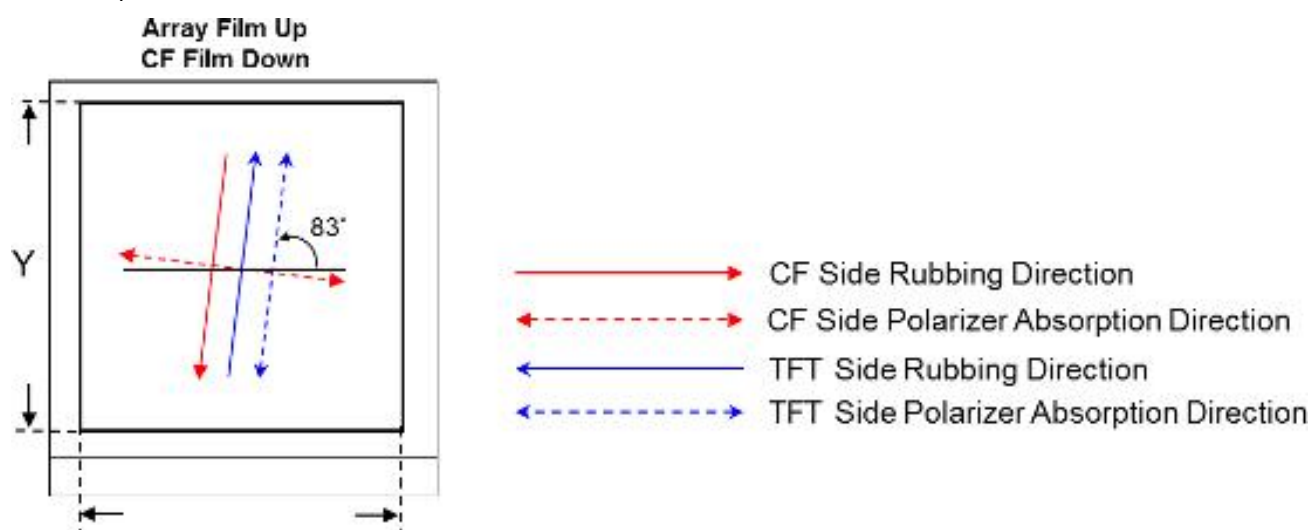
Note (3) Definition of Response Time: Sum of TR and TF



Note (4) Definition of optical measurement setup



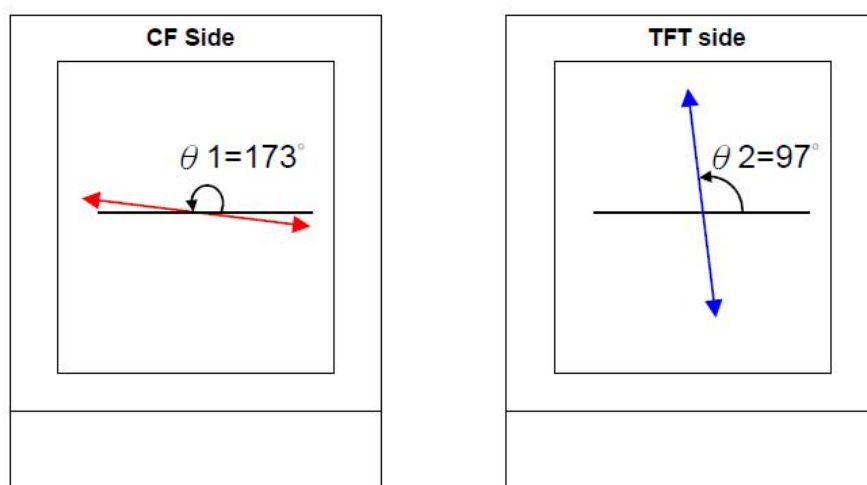
Note (5) Rubbing Direction (The different Rubbing Direction will cause the different optima view direction.)



Item	Specifications	Unit	Note
Rubbing Direction	83° (TFT) / 263° (CF)	degree	1-domain IPS-pro
Absorption axis of Polarizer	83° (TFT) / 173° (CF)	degree	Array Film Up CF Film Down

CF side polarizing absorption angle $\theta 1=173^\circ$ (Protective film on top, glue layer face down)

TFT side polarizing absorption angle $\theta 2=97^\circ$ (Protective film on top, glue layer face down)



11. Reliability

11.1. MTBF

The LCD module shall be designed to meet a minimum MTBF value of 50000 hours with normal.

11.2. Test Condition

No	Item	Condition	Criteria
1	High Temperature Operating	60°C*24Hrs	1. No Defect Of Operational Function In Room Temperature Are Allowable. 2. IDD of LCM in Pre-and Post-Test Should Follow Specification.
2	Low Temperature Operating	-20°C*24Hrs	
3	High Humidity Storage	50°C*90%RH*24Hrs	
4	High Temperature Storage	70°C*24Hrs	
5	Low Temperature Storage	-30°C*24Hrs	
6	Thermal Cycling Test Storage	-	
7	Packing vibration	-	
8	Electrical Static Discharge	-	
		-	
9	Drop Test (Packaged)	-	

Note1. The test samples should be applied to only one test item.

Note2. Sample size for each test item is 2pcs.

Note3. No defection function allowable.

12. Precautions

12.1. Storage Conditions

- 12.1.1. Store the panel or module in a dark place where the temperature is $23\pm5^{\circ}\text{C}$ and the humidity is below $45\pm20\%\text{RH}$.
- 12.1.2. Store in anti-static electricity container.
- 12.1.3. Store in clean environment, free from dust, active gas, and solvent.
- 12.1.4. Do not place the module near organics solvents or corrosive gases.
- 12.1.5. Do not crush, shake, or jolt the module.
- 12.1.6. Strong light exposure causes degradation of polarizer and color filter.

12.2. Handling Precautions

- 12.2.1. Avoid static electricity, which can damage the CMOS LSI.
- 12.2.2. The polarizing plate of the display is very fragile, please handle it very carefully.
- 12.2.3. Do not give external shock.
- 12.2.4. Do not apply excessive force on the surface.
- 12.2.5. Do not wipe the polarizer with dry cloth, as it might cause scratch. If the surface of the LCD needs to be cleaned, wipe it swiftly with cotton or other soft cloth soaked with petroleum IPA, do not use other chemicals.
- 12.2.6. Reverse and use within ratings in order to keep performance and prevent damage
- 12.2.7. Do not remove the panel or frame from the module.
- 12.2.8. Except for soldering the interface, do not make any alterations or modifications with a soldering iron; Ensure welding temperature at 320°C to 350°C , the welding time control within the 10 s, welding note don't stay too long in the same place to avoid scald FPC.

12.3. Limited Warranty

- 12.3.1. Our warranty liability is limited to repair and/or replacement. We will not be responsible for any consequential loss. (我们的保证责任仅限于修理和/或更换。我们将不负任何相应的损失。)
- 12.3.2. If possible, we suggest customer to use up all modules in six months. If the module storage time over twelve months, we suggest that recheck it before the module be used. (如果可能，我们建议客户在 6 个月内用完所有模块。如果模块存放时间超过 12 个月，我们建议在使用模块前重新检查。)
- 12.3.3. The warranty period is twelve months from the date of delivery. Buyer shall complete the assembly of all processes within twelve months of validity. During the warranty period, if the product quality problems, our company will be responsible for repair and replacement. All products must be stored and handled in accordance with regulations. Under warranty. When the goods do not comply with the above terms, we do not provide warranty services. (保修期为交货之日起十二个月。买方应在 12 个月内完成所有流程的组装。在保修期内，如果产品出现质量问题，我公司将负责维修和更换。所有产品必须按照规定储存和处理。在保修期内。当货物不符合上述条款时，我们不提供保修服务。)